Vishay Siliconix



Parameter	Symbol	Test Conditions		Min.	Typ. <sup>a</sup>	Max.	Unit	
Static				1				
Drain-Source Breakdown Voltage	V	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA Ch-1		30			V	
	V <sub>DS</sub>	$V_{GS} = 0 V, I_{D} = 1 mA$	Ch-2	30			- V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Γ <sub>J</sub> I <sub>D</sub> = 250 μA C			32			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	Γ <sub>J</sub> I <sub>D</sub> = 250 μA			- 6		mV/°	
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	Ch-1	1		3	V	
		$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	Ch-2	1		3		
Gate-Body Leakage		$V_{DS} = 0 V, V_{GS} = \pm 20 V$	Ch-1			100	nA nA	
	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	Ch-2			100		
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	Ch-1		0.016	0.10	1	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ Ch-2				0.001		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 100 ^{\circ}\text{C}$	Ch-1		1.1	10	mA	
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 100 ^{\circ}\text{C}$	Ch-2			0.025	1	
On-State Drain Current <sup>b</sup>		$V_{DS} = 5 V, V_{GS} = 10 V$	Ch-1	20			<u> </u>	
	I <sub>D(on)</sub>	$V_{DS} = 5 V, V_{GS} = 10 V$	Ch-2	20			A	
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	Ch-1		0.0156	0.020	- Ω	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	Ch-2		0.0156	0.020		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	Ch-1		0.019	0.025		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5 \text{ A}$	Ch-2		0.019	0.025		
_		$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	Ch-1		29		_	
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 8 \text{ A}$ Ch-2			29		S	
Dynamic <sup>a</sup>			•		•			
Input Capacitance	C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>		Ch-1		950		pF	
Input Capacitance		Channel-1 $V_{-1} = 15 V V_{-1} = 0 V f = 1 MHz$	Ch-2		950			
Output Capacitance		$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	Ch-1		185			
Output Capacitance		Channel-2	Ch-2		155			
Reverse Transfer Capacitance		$V_{DS}$ = 15 V, $V_{GS}$ = 0 V, f = 1 MHz	Ch-1		65			
			Ch-2		65			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$	Ch-1		16.5	25		
		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$	Ch-2		16.5	25	nC	
		Channel-1	Ch-1		7.3	11		
		$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8 \text{ A}$	Ch-2		7.3	11		
Gate-Source Charge	Q <sub>gs</sub>		Ch-1		2.7			
Gate-Drain Charge	Q <sub>gd</sub>	Channel-2	Ch-2		2.7			
		$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8 \text{ A}$	Ch-1		2.1			
	R <sub>g</sub>		Ch-2	0.0	2.1	0.4	<u> </u>	
Gate Resistance		f = 1 MHz	Ch-1	0.2	1.2	2.4	Ω	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.



# Si4834CDY Vishay Siliconix

Parameter	Symbol	Test Conditions		Min.	Typ. <sup>a</sup>	Max.	Unit
Dynamic <sup>a</sup>		•					
Turn-On Delay Time	t <sub>d(on)</sub>	Channel-1	Ch-1		10	20	
	u(on)	$V_{DD} = 15 \text{ V}, \text{ R}_{I} = 3 \Omega$	Ch-2		9	18	
Rise Time		Ch-1		10	20		
			Ch-2		11 18	20 35	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	Channel-2	Ch-1 Ch-2		18	35	
		$V_{DD} = 15 V, R_L = 3 \Omega$	Ch-1		9	18	
Fall Time	t <sub>f</sub>	$I_D \cong$ 5 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$	Ch-2		8	16	
		Channel-1	Ch-1		17	35	
Turn-On Delay Time	t <sub>d(on)</sub>		Ch-2		17	35	
Rise Time	t <sub>r</sub>	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 3 \Omega$	Ch-1		12	24	
		$I_D \cong 5$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$	Ch-2		12	24	
Turn-Off Delay Time	t <sub>d(off)</sub>	Channel-2 V <sub>DD</sub> = 15 V, R <sub>L</sub> = 3 $\Omega$	Ch-1		19	35	
			Ch-2		18	35	
Fall Time		$\text{I}_\text{D}\cong$ 5 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$	Ch-1		10	20	
	•		Ch-2		10	20	
Drain-Source Body Diode Characteristic	s			[	1		1
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C	Ch-1			2.6	- A
			Ch-2			2.6 30	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>		Ch-1 Ch-2			30	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1 A	Ch-1		0.46	0.51	v
		$I_{S} = 1 A$	Ch-2		0.40	1.1	
		.5	Ch-1		17	34	
Body Diode Reverse Recovery Time			Ch-2		17	34	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	Channel-1	Ch-1		7	14	nC
		$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$	Ch-2		9	18	
Reverse Recovery Fall Time	t <sub>a</sub>	Channel-2	Ch-1		9		
		$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$	Ch-2		10		- ns
Reverse Recovery Rise Time	t <sub>b</sub>		Ch-1		8		
Reverse Recovery Rise Time			Ch-2		7		

Notes:

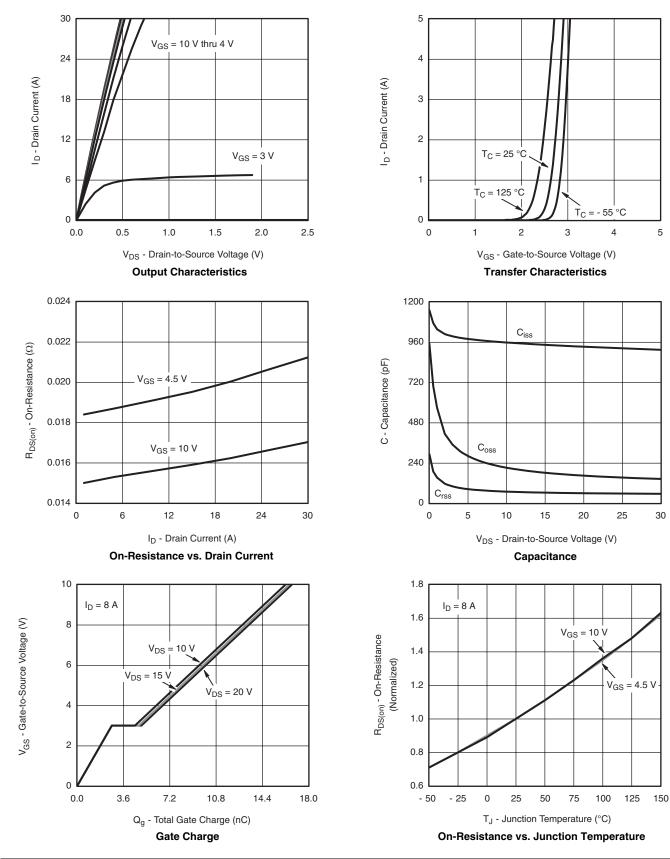
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



#### CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



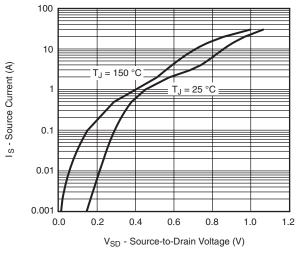
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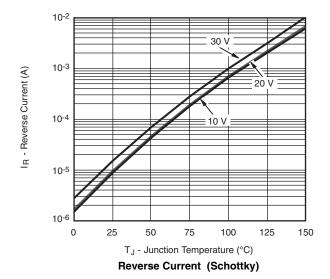


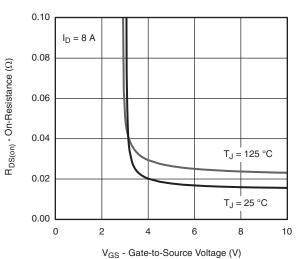
Vishay Siliconix



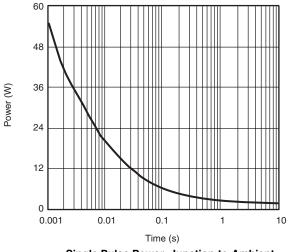




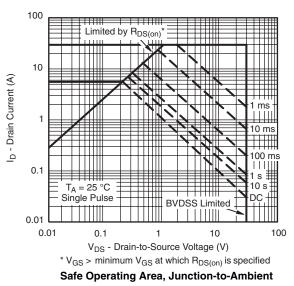




On-Resistance vs. Gate-to-Source Voltage



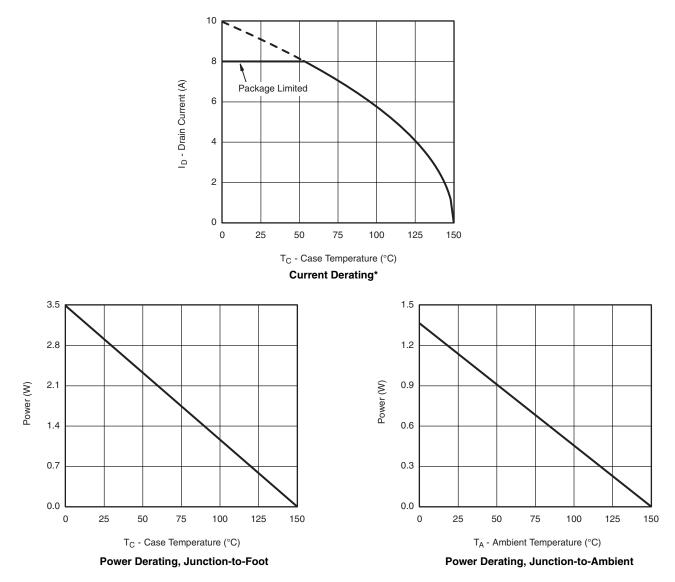
Single Pulse Power, Junction-to-Ambient



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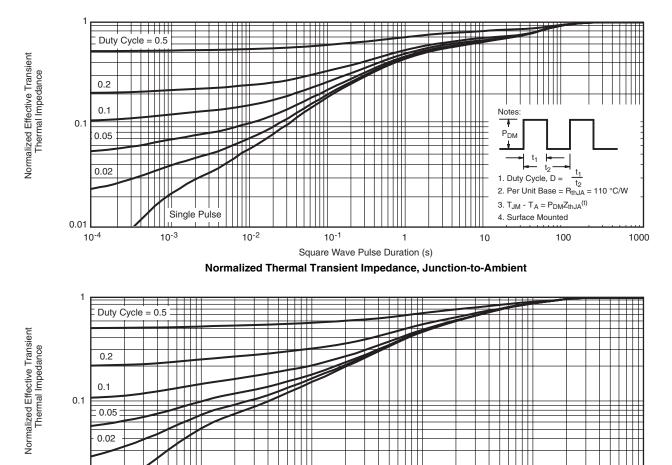




\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### CHANNEL-1 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

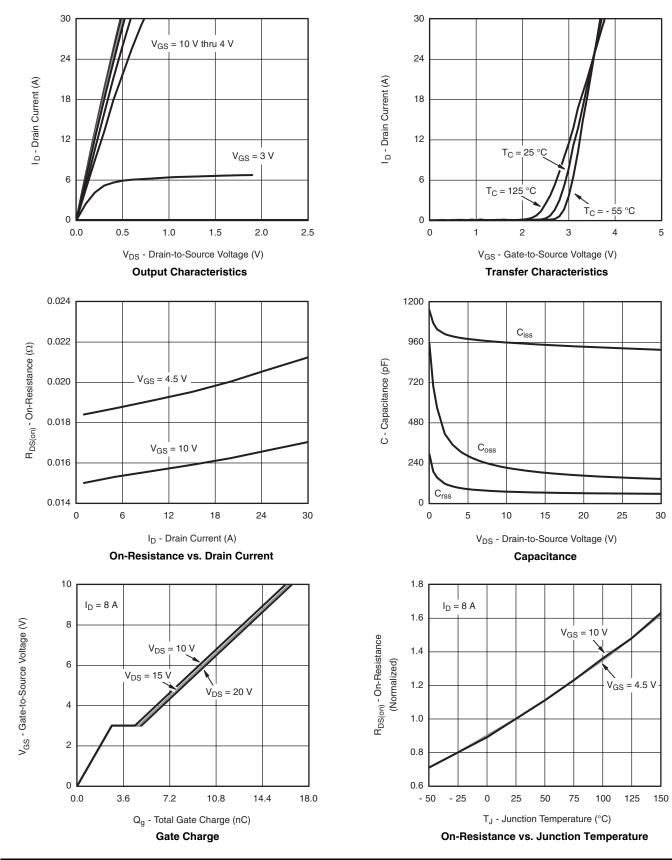
0.01

Single Pulse

10



#### CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



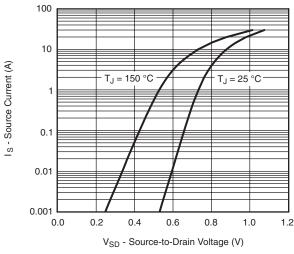
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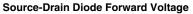


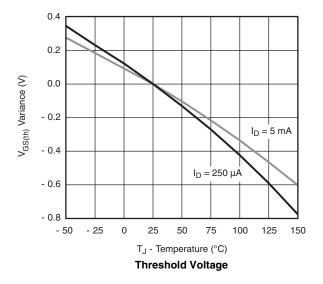


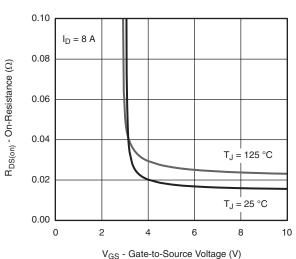
Vishay Siliconix

#### CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

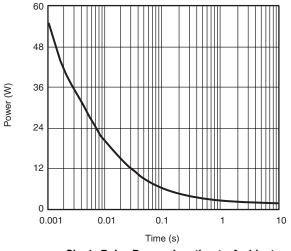




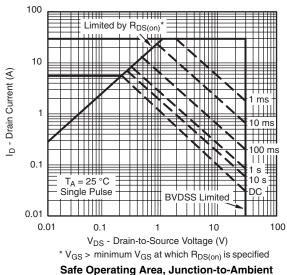




On-Resistance vs. Gate-to-Source Voltage



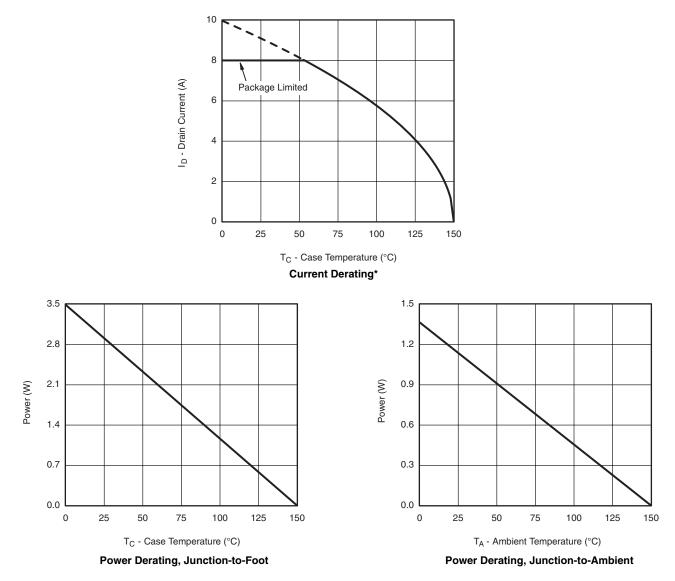
Single Pulse Power, Junction-to-Ambient



Document Number: 68790 S09-2109-Rev. B, 12-Oct-09

### Vishay Siliconix



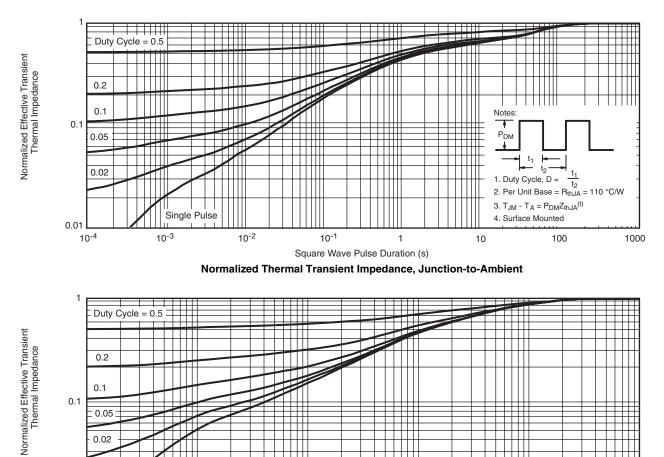


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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### Si4834CDY Vishay Siliconix



#### CHANNEL-2 TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Foot

10-2

10-1

1

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg268790">www.vishay.com/ppg268790</a>.

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0.1

0.05

0.02

Single Pulse

10<sup>-3</sup>

0.1

0.01 10-4

10

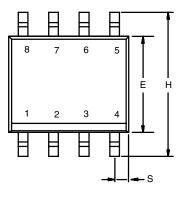


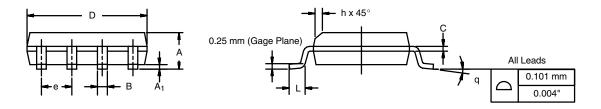
### Package Information

Vishay Siliconix

#### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





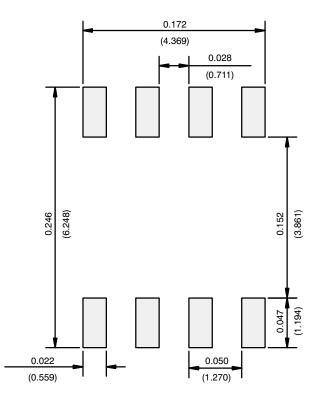
	MILLIM	IETERS	INCHES				
DIM	Min	Мах	Min	Max			
A	1.35	1.75	0.053	0.069			
A <sub>1</sub>	0.10	0.20	0.004	0.008			
В	0.35	0.51	0.014	0.020			
С	0.19	0.25	0.0075	0.010			
D	4.80	5.00	0.189	0.196			
E	3.80	4.00	0.150	0.157			
е	1.27 BSC		0.050 BSC				
н	5.80	6.20	0.228	0.244			
h	0.25	0.50	0.010	0.020			
L	0.50	0.93	0.020	0.037			
q	0°	8°	0°	8°			
S	0.44	0.64	0.018	0.026			
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498							

### **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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